

74LV132-Q100

Quad 2-input NAND Schmitt trigger

Rev. 1 — 11 November 2013

Product data sheet

1. General description

The 74LV132-Q100 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC132-Q100 and 74HCT132-Q100.

The 74LV132-Q100 contains four 2-input NAND gates which accept standard input signals. These gates are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The gate switches at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ and from $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$
- Wide operating voltage: 1.0 V to 5.5 V
- Optimized for low voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7\text{ V}$ and $V_{CC} = 3.6\text{ V}$
- Typical output ground bounce $< 0.8\text{ V}$ at $V_{CC} = 3.3\text{ V}$ and $T_{amb} = 25\text{ }^{\circ}\text{C}$
- Typical HIGH-level output voltage (V_{OH}) undershoot: $> 2\text{ V}$ at $V_{CC} = 3.3\text{ V}$ and $T_{amb} = 25\text{ }^{\circ}\text{C}$
- ESD protection:
 - ◆ MIL-STD-883, method 3015 exceeds 2000 V
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115-A exceeds 200 V ($C = 200\text{ pF}$, $R = 0\text{ }\Omega$)
- Multiple package options

3. Applications

- Wave and pulse shapers for highly noisy environments
- Astable multivibrators
- Monostable multivibrators

4. Ordering information

Table 1. Ordering information

| Type number | Package | | | Version |
|----------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | |
| 74LV132D-Q100 | -40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74LV132PW-Q100 | -40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74LV132BQ-Q100 | -40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

5. Functional diagram

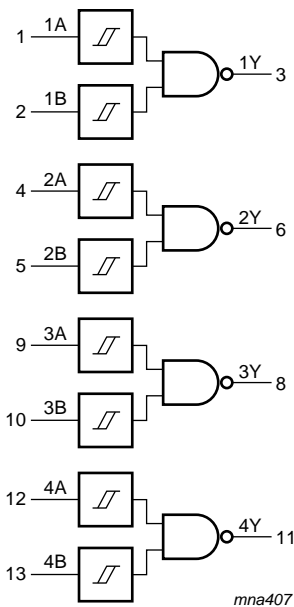


Fig 1. Logic symbol

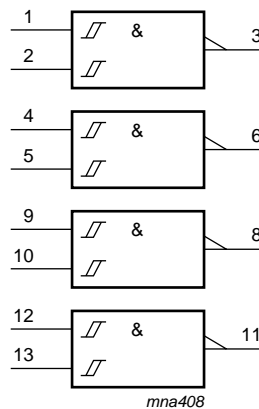


Fig 2. IEC logic symbol

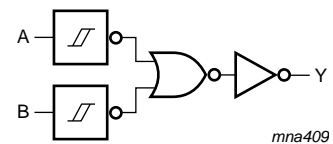
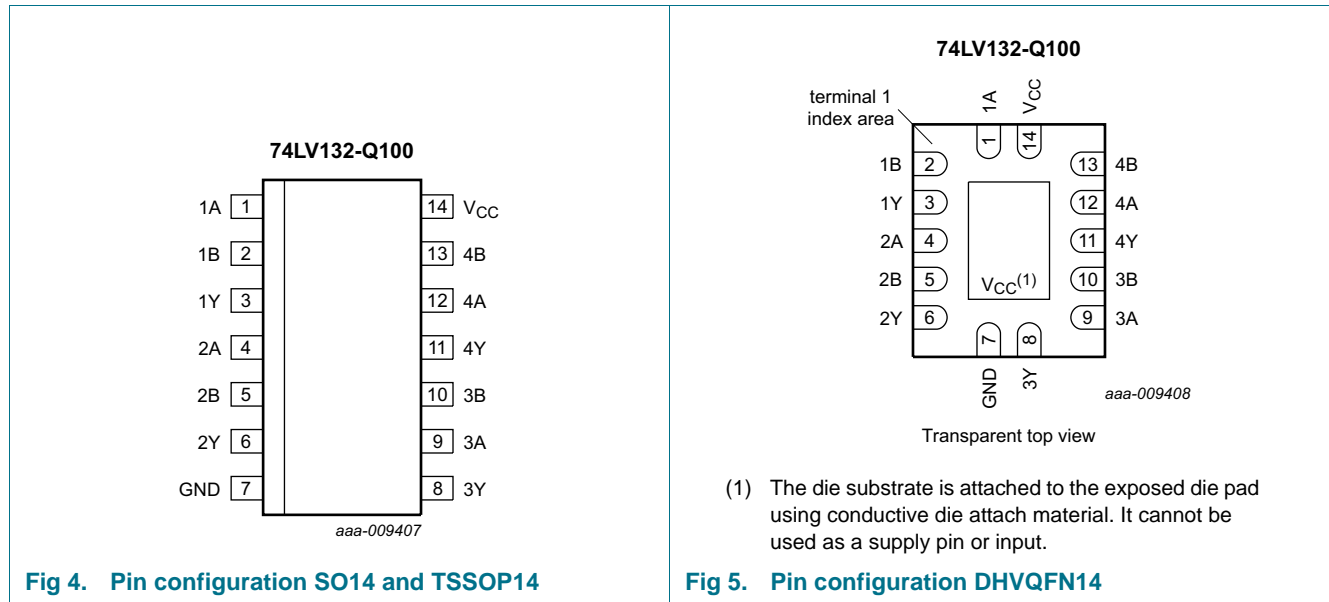


Fig 3. Logic diagram (one gate)

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|-----|----------------|
| 1A | 1 | data input |
| 1B | 2 | data input |
| 1Y | 3 | data output |
| 2A | 4 | data input |
| 2B | 5 | data input |
| 2Y | 6 | data output |
| GND | 7 | ground (0 V) |
| 3Y | 8 | data output |
| 3A | 9 | data input |
| 3B | 10 | data input |
| 4Y | 11 | data output |
| 4A | 12 | data input |
| 4B | 13 | data input |
| V _{CC} | 14 | supply voltage |

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level.

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | L | H |
| L | H | H |
| H | L | H |
| H | H | L |

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|-------|----------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| I_{IK} | input clamping current | $V_I < -0.5 \text{ V}$ or $V_I > V_{CC} + 0.5 \text{ V}$ | [1] - | ± 20 | mA |
| I_{OK} | output clamping current | $V_O < -0.5 \text{ V}$ or $V_O > V_{CC} + 0.5 \text{ V}$ | [1] - | ± 50 | mA |
| I_O | output current | $V_O = -0.5 \text{ V}$ to $(V_{CC} + 0.5 \text{ V})$ | - | ± 25 | mA |
| I_{CC} | supply current | | - | 50 | mA |
| I_{GND} | ground current | | -50 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40 \text{ °C}$ to $+125 \text{ °C}$ | | | |
| | SO14 package | | [2] - | 500 | mW |
| | TSSOP14 package | | [3] - | 500 | mW |
| | DHVQFN14 package | | [4] - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] P_{tot} derates linearly with 8 mW/K above 70 °C.

[3] P_{tot} derates linearly with 5.5 mW/K above 60 °C.

[4] P_{tot} derates linearly with 4.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|---------------------|------------|-----|-----|----------|------|
| V_{CC} | supply voltage | [1] | 1.0 | 3.3 | 5.5 | V |
| V_I | input voltage | | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | +25 | +125 | °C |

[1] The static characteristics are guaranteed from $V_{CC} = 1.2$ V to $V_{CC} = 5.5$ V. LV devices are guaranteed to function down to $V_{CC} = 1.0$ V (with input levels GND or V_{CC}).

10. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|-----------------|----------------------------------|---|------------------|---------|------|-------------------|------|---------------|
| | | | Min | Typ [1] | Max | Min | Max | |
| V_{OH} | HIGH-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | | | | |
| | | $I_O = -100 \mu\text{A}; V_{CC} = 1.2$ V | - | 1.2 | - | - | - | V |
| | | $I_O = -100 \mu\text{A}; V_{CC} = 2.0$ V | 1.8 | 2.0 | - | 1.8 | - | V |
| | | $I_O = -100 \mu\text{A}; V_{CC} = 2.7$ V | 2.5 | 2.7 | - | 2.5 | - | V |
| | | $I_O = -100 \mu\text{A}; V_{CC} = 3.0$ V | 2.8 | 3.0 | - | 2.8 | - | V |
| | | $I_O = -100 \mu\text{A}; V_{CC} = 4.5$ V | 4.3 | 4.5 | - | 4.3 | - | V |
| | | $I_O = -6$ mA; $V_{CC} = 3.0$ V | 2.4 | 2.82 | - | 2.2 | - | V |
| | $I_O = -12$ mA; $V_{CC} = 4.5$ V | 3.6 | 4.2 | - | 3.5 | - | V | |
| V_{OL} | LOW-level output voltage | $V_I = V_{T+}$ or V_{T-} | | | | | | |
| | | $I_O = 100 \mu\text{A}; V_{CC} = 1.2$ V | - | 0 | - | - | - | V |
| | | $I_O = 100 \mu\text{A}; V_{CC} = 2.0$ V | - | 0 | 0.2 | - | 0.2 | V |
| | | $I_O = 100 \mu\text{A}; V_{CC} = 2.7$ V | - | 0 | 0.2 | - | 0.2 | V |
| | | $I_O = 100 \mu\text{A}; V_{CC} = 3.0$ V | - | 0 | 0.2 | - | 0.2 | V |
| | | $I_O = 100 \mu\text{A}; V_{CC} = 4.5$ V | - | 0 | 0.2 | - | 0.2 | V |
| | | $I_O = 6$ mA; $V_{CC} = 3.0$ V | - | 0.25 | 0.40 | - | 0.50 | V |
| | $I_O = 12$ mA; $V_{CC} = 4.5$ V | - | 0.35 | 0.55 | - | 0.65 | V | |
| I_I | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V | - | - | 1.0 | - | 1.0 | μA |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V | - | - | 20.0 | - | 40 | μA |
| ΔI_{CC} | additional supply current | per input; $V_I = V_{CC} - 0.6$ V; $V_{CC} = 2.7$ V to 3.6 V | - | - | 500 | - | 850 | μA |
| C_I | input capacitance | | - | 3.5 | - | - | - | pF |

[1] Typical values are measured at $T_{amb} = 25$ °C.

11. Dynamic characteristics

Table 7. Dynamic characteristics

$GND = 0\text{ V}$; for test circuit, see [Figure 7](#).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|----------|-------------------------------|---|------------------|--------------------|-----|-------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | |
| t_{pd} | propagation delay | nA, nB to nY; see Figure 6 ^[2] | | | | | | |
| | | $V_{CC} = 1.2\text{ V}$ | - | 65 | - | - | - | ns |
| | | $V_{CC} = 2.0\text{ V}$ | - | 18 | 34 | - | 43 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | - | 15 | 24 | - | 30 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$; $C_L = 15\text{ pF}$ ^[3] | - | 10 | - | - | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ ^[3] | - | 12 | 20 | - | 25 | ns |
| C_{PD} | power dissipation capacitance | $C_L = 50\text{ pF}$; $f_i = 1\text{ MHz}$; ^[4] | - | 24 | - | - | - | pF |
| | | $V_i = GND\text{ to }V_{CC}$ | | | | | | |

[1] All typical values are measured at $T_{amb} = 25\text{ °C}$.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Typical values are measured at nominal supply voltage ($V_{CC} = 3.3\text{ V}$ and $V_{CC} = 5.0\text{ V}$).

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz, f_o = output frequency in MHz

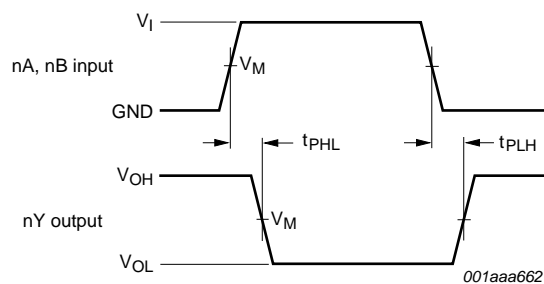
C_L = output load capacitance in pF

V_{CC} = supply voltage in V

N = number of inputs switching

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

12. Waveforms



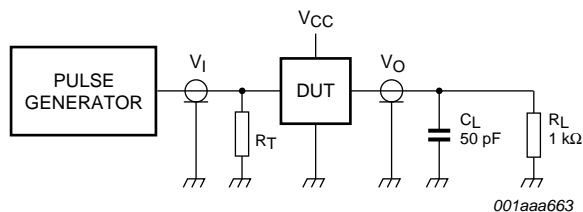
Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 6. The input (nA, nB) to output (nY) propagation delays

Table 8. Measurement points

| Supply voltage V_{CC} | Input V_M | Output V_M |
|----------------------------|----------------|-----------------|
| < 2.7 V | $0.5V_{CC}$ | $0.5V_{CC}$ |
| 2.7 V to 3.6 V | 1.5 V | 1.5 V |
| ≥ 4.5 V | $0.5V_{CC}$ | $0.5V_{CC}$ |



Test data is given in [Table 9](#).

Definitions test circuit:

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

Fig 7. Load circuit for switching times

Table 9. Test data

| Supply voltage V_{CC} | Input V_I | t_r, t_f |
|----------------------------|----------------|---------------|
| < 2.7 V | V_{CC} | ≤ 2.5 ns |
| 2.7 V to 3.6 V | 2.7 V | ≤ 2.5 ns |
| ≥ 4.5 V | V_{CC} | ≤ 2.5 ns |

13. Transfer characteristics

Table 10. Transfer characteristics

$GND = 0$ V; for test circuit, see [Figure 7](#).

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|----------|----------------------------------|------------------------------|------------------|--------------------|-----|-------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | |
| V_{T+} | positive-going threshold voltage | see Figure 6 | | | | | | |
| | | $V_{CC} = 1.2$ V | - | 0.70 | - | - | - | V |
| | | $V_{CC} = 2.0$ V | 0.8 | 1.10 | 1.4 | 0.8 | 1.4 | V |
| | | $V_{CC} = 2.7$ V | 1.0 | 1.45 | 2.0 | 1.0 | 2.0 | V |
| | | $V_{CC} = 3.0$ V | 1.2 | 1.60 | 2.2 | 1.2 | 2.2 | V |
| | | $V_{CC} = 3.6$ V | 1.5 | 1.95 | 2.4 | 1.5 | 2.4 | V |
| | | $V_{CC} = 4.5$ V | 1.7 | 2.50 | 3.2 | 1.7 | 3.2 | V |
| | $V_{CC} = 5.5$ V | 2.1 | 3.00 | 3.9 | 2.1 | 3.9 | V | |

Table 10. Transfer characteristics ...continued
GND = 0 V; for test circuit, see Figure 7.

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|----------|--|------------------------------|------------------|--------------------|-----|-------------------|-----|------|
| | | | Min | Typ ^[1] | Max | Min | Max | |
| V_{T-} | negative-going threshold voltage | see Figure 6 | | | | | | |
| | | $V_{CC} = 1.2 \text{ V}$ | - | 0.34 | - | - | - | V |
| | | $V_{CC} = 2.0 \text{ V}$ | 0.3 | 0.65 | 0.9 | 0.3 | 0.9 | V |
| | | $V_{CC} = 2.7 \text{ V}$ | 0.4 | 0.90 | 1.4 | 0.4 | 1.4 | V |
| | | $V_{CC} = 3.0 \text{ V}$ | 0.6 | 1.05 | 1.5 | 0.6 | 1.5 | V |
| | | $V_{CC} = 3.6 \text{ V}$ | 0.8 | 1.30 | 1.8 | 0.8 | 1.8 | V |
| | | $V_{CC} = 4.5 \text{ V}$ | 0.9 | 1.60 | 2.0 | 0.9 | 2.0 | V |
| V_H | hysteresis voltage ($V_{T+} - V_{T-}$); see Figure 6 | $V_{CC} = 1.2 \text{ V}$ | - | 0.3 | - | - | - | V |
| | | $V_{CC} = 2.0 \text{ V}$ | 0.2 | 0.55 | 0.8 | 0.2 | 0.8 | V |
| | | $V_{CC} = 2.7 \text{ V}$ | 0.3 | 0.60 | 1.1 | 0.3 | 1.1 | V |
| | | $V_{CC} = 3.0 \text{ V}$ | 0.4 | 0.65 | 1.2 | 0.4 | 1.2 | V |
| | | $V_{CC} = 3.6 \text{ V}$ | 0.4 | 0.70 | 1.2 | 0.4 | 1.2 | V |
| | | $V_{CC} = 4.5 \text{ V}$ | 0.4 | 0.80 | 1.4 | 0.4 | 1.4 | V |
| | | $V_{CC} = 5.5 \text{ V}$ | 0.6 | 1.00 | 1.5 | 0.6 | 1.5 | V |

[1] All typical values are measured at $T_{amb} = 25 \text{ °C}$.

14. Waveforms transfer characteristics

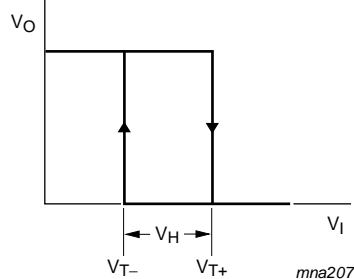
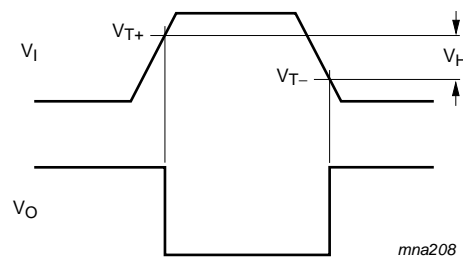
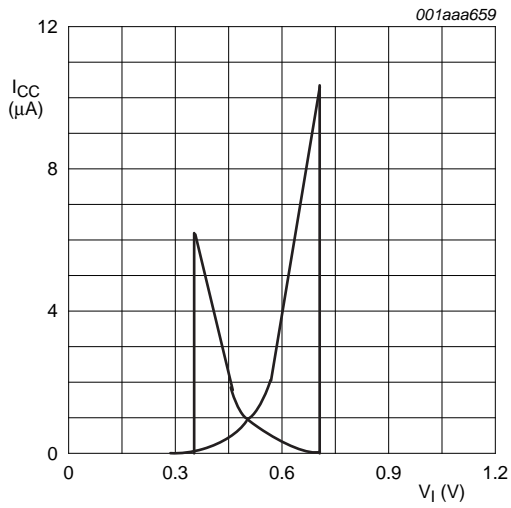


Fig 8. Transfer characteristic



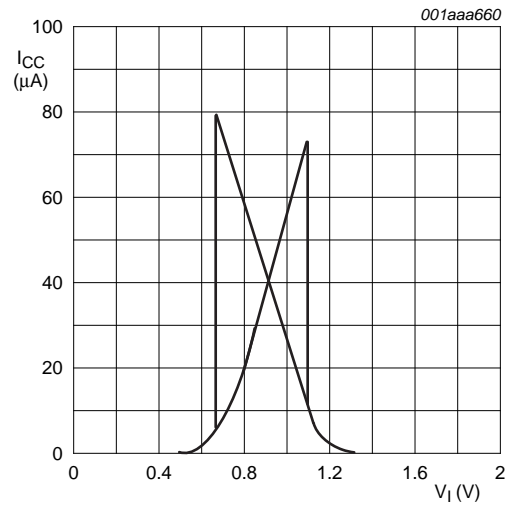
V_{T+} and V_{T-} limits at 70 % and 20 %.

Fig 9. Definition of V_{T+} , V_{T-} and V_H



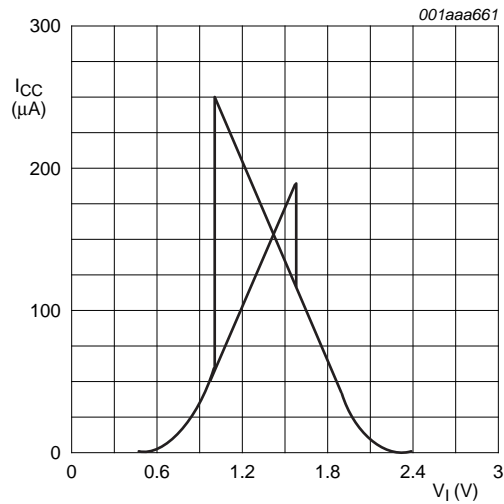
$V_{CC} = 1.2 \text{ V.}$

Fig 10. Typical 74LV132-Q100 transfer characteristics



$V_{CC} = 2.0 \text{ V.}$

Fig 11. Typical 74LV132-Q100 transfer characteristics



$V_{CC} = 3.0 \text{ V.}$

Fig 12. Typical 74LV132-Q100 transfer characteristics

15. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

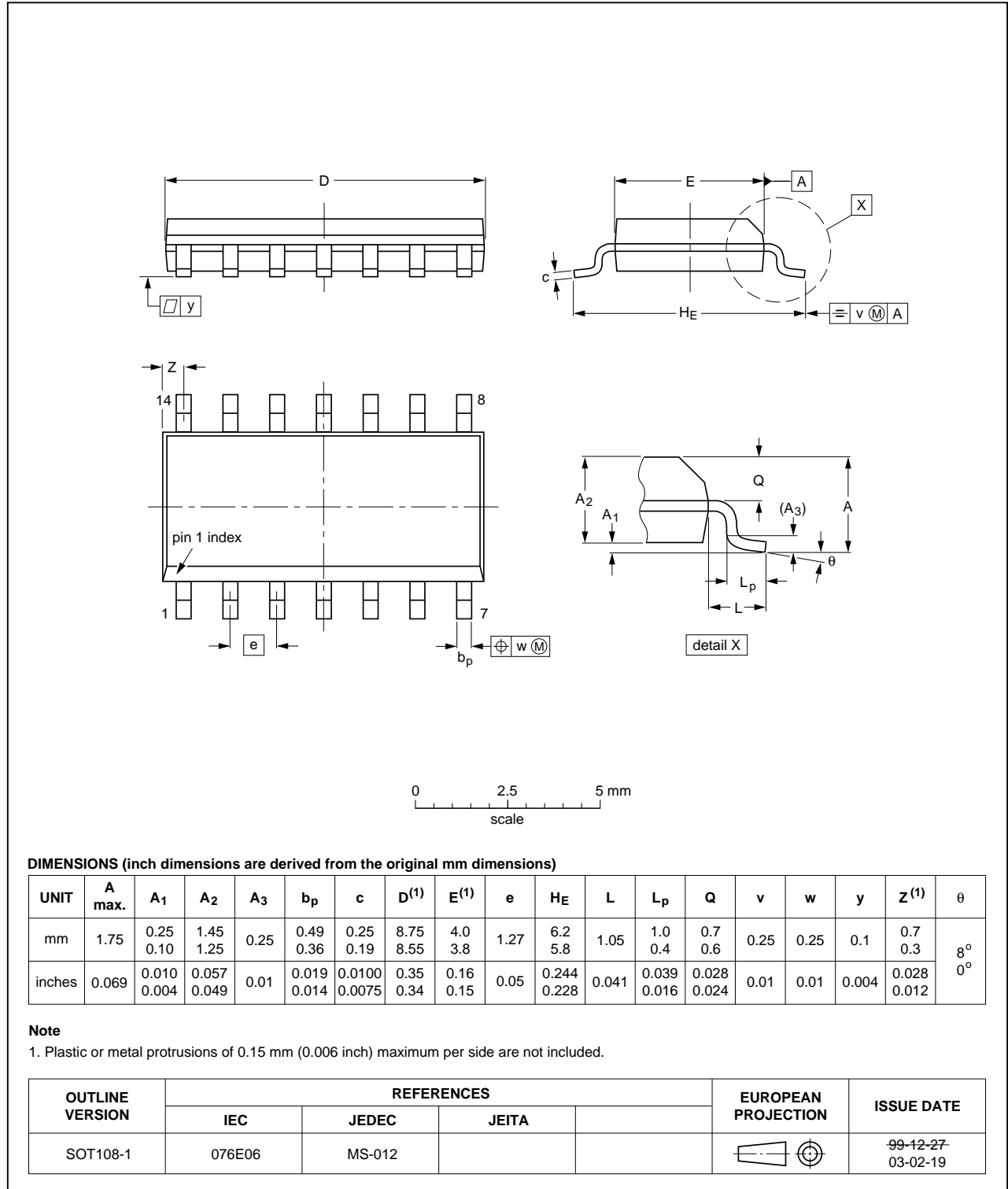


Fig 13. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

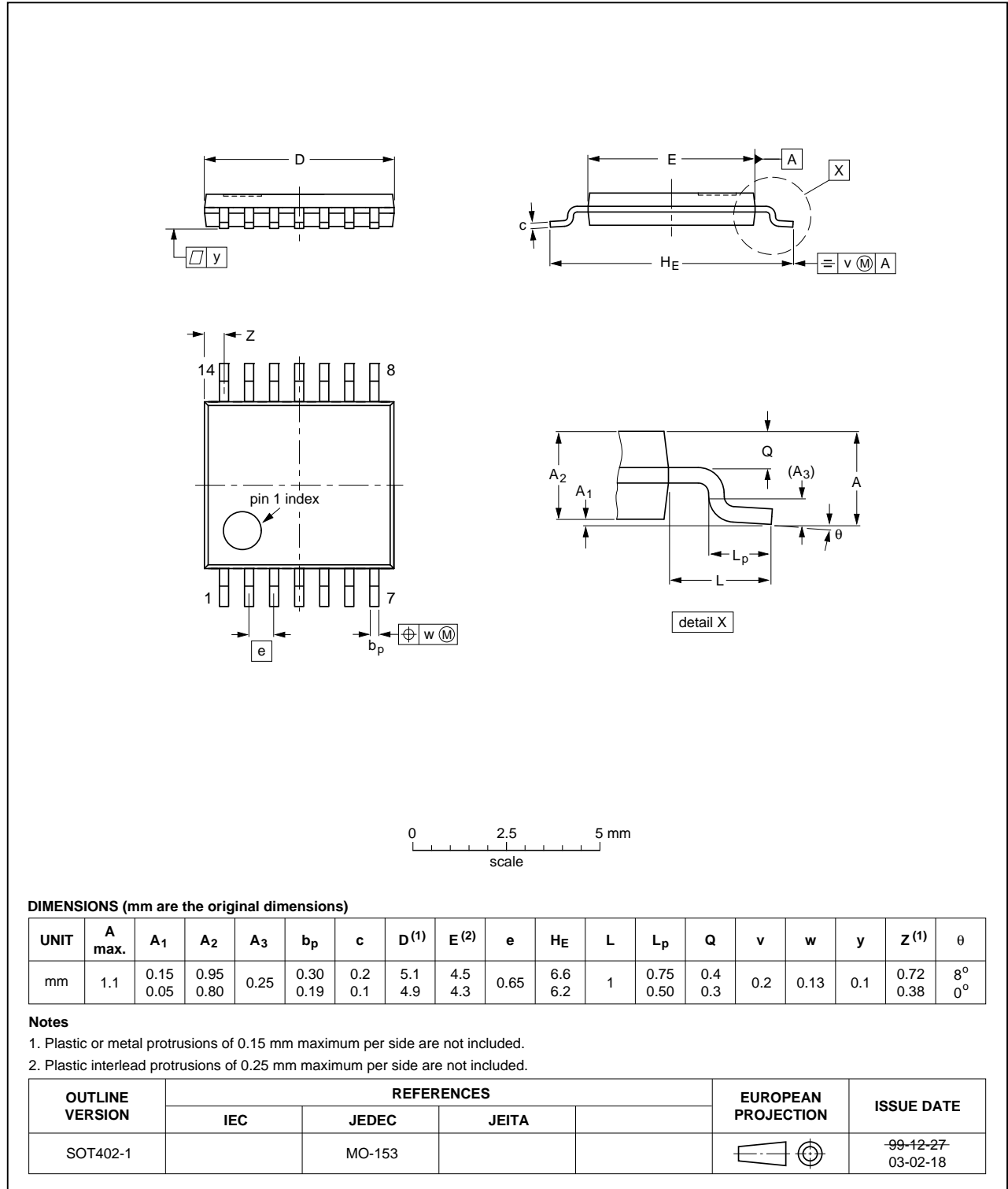


Fig 14. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

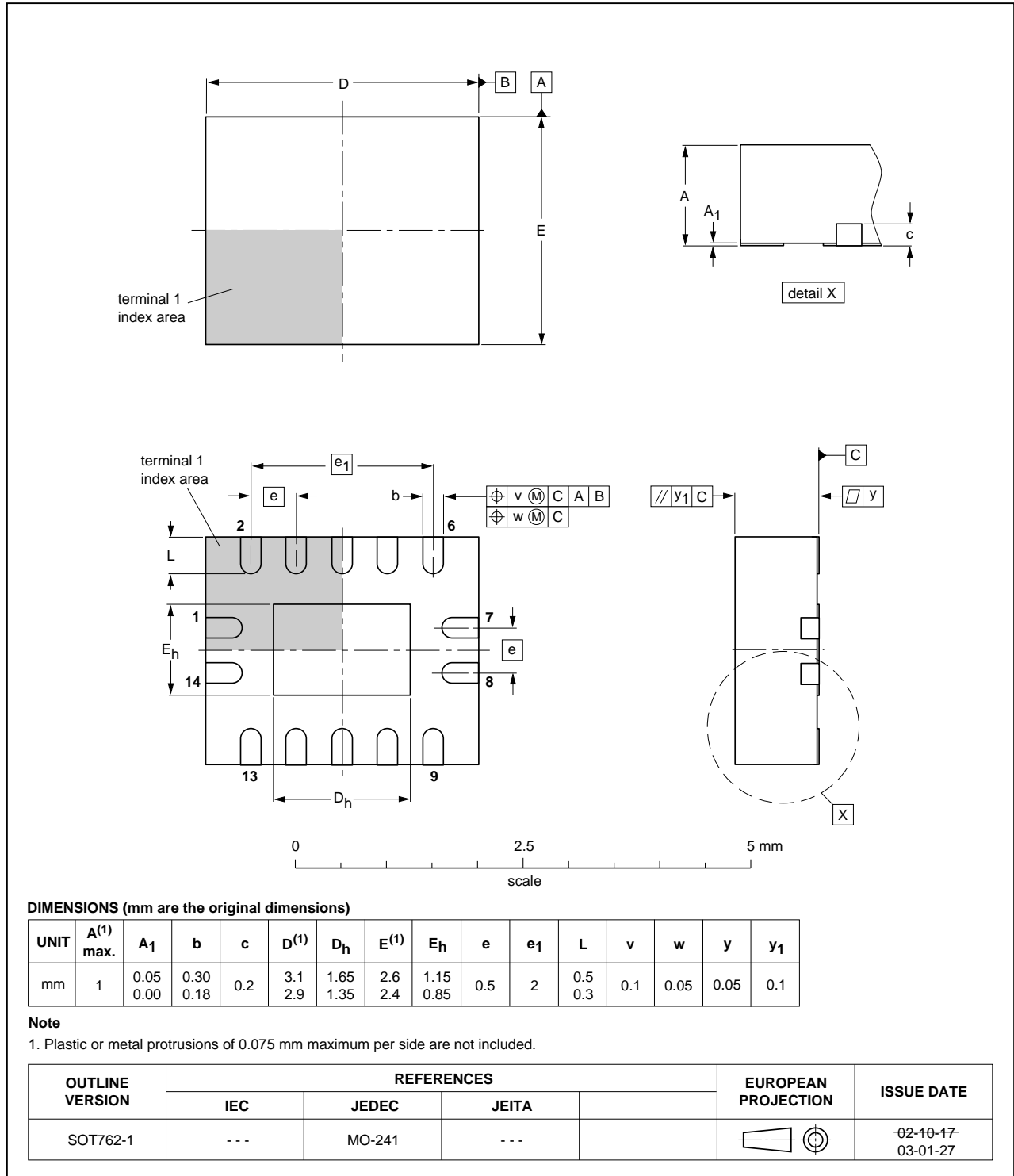


Fig 15. Package outline SOT762-1 (DHVQFN14)

16. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

17. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|--------------|--------------------|---------------|------------|
| 74LV132_Q100 v.1 | 20131111 | Product data sheet | - | - |

18. Legal information

18.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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19. Contact information

For more information, please visit: <http://www.nexperia.com>

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20. Contents

| | | |
|------|--|----|
| 1 | General description | 1 |
| 2 | Features and benefits | 1 |
| 3 | Applications | 1 |
| 4 | Ordering information | 2 |
| 5 | Functional diagram | 2 |
| 6 | Pinning information | 3 |
| 6.1 | Pinning | 3 |
| 6.2 | Pin description | 3 |
| 7 | Functional description | 4 |
| 8 | Limiting values | 4 |
| 9 | Recommended operating conditions | 5 |
| 10 | Static characteristics | 5 |
| 11 | Dynamic characteristics | 6 |
| 12 | Waveforms | 6 |
| 13 | Transfer characteristics | 7 |
| 14 | Waveforms transfer characteristics | 8 |
| 15 | Package outline | 10 |
| 16 | Abbreviations | 13 |
| 17 | Revision history | 13 |
| 18 | Legal information | 14 |
| 18.1 | Data sheet status | 14 |
| 18.2 | Definitions | 14 |
| 18.3 | Disclaimers | 14 |
| 18.4 | Trademarks | 15 |
| 19 | Contact information | 15 |
| 20 | Contents | 16 |